#### OSLON® Signal

The OSLON® Signal combine a compact size (small footprint: 3x3mm) with a high efficiency and an electrically insulated thermal pad.







#### **Applications**

- Architecture / Garden Lighting (LED & Laser)
- Signalling

- Emergency Vehicle Lighting

#### Features:

- Package: SMD ceramic package with silicone lens
- Chip technology: UX:3
- Typ. Radiation: 120° (Lambertian emitter)
- Color:  $\lambda_{dom} = 475 \text{ nm} (\bullet \text{ blue})$
- Corrosion Robustness Class: 3B
- ESD: 8 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)

### **Ordering Information**

Туре	Luminous Flux <sup>1)</sup> $I_F = 350 \text{ mA}$ $\Phi_V$	Ordering Code
LB CRBP-HYJZ-46-8E8F	33 71 lm	Q65112A6186



Maximum Ratings			
Parameter	Symbol		Values
Operating Temperature	T <sub>op</sub>	min. max.	-40 °C 120 °C
Storage Temperature	$T_{stg}$	min. max.	-40 °C 120 °C
Junction Temperature	T <sub>j</sub>	max.	150 °C
Junction Temperature for short time applications*	$T_{j}$	max.	175 °C
Forward current T <sub>S</sub> = 25 °C	I <sub>F</sub>	min. max.	30 mA 1000 mA
Surge Current $t \le 10 \ \mu s; \ D = 0.005 \ ; \ T_s = 25 \ ^{\circ}C$	I <sub>FS</sub>	max.	2000 mA
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)	$V_{ESD}$		8 kV
Reverse current 2)	I <sub>R</sub>	max.	50 mA

<sup>\*</sup> The median lifetime (L70/B50) for Tj = 175 $^{\circ}$ C is 100h.

### **Characteristics**

 $I_F$  = 350 mA;  $T_S$  = 25 °C

Parameter	Symbol		Values
Peak Wavelength	$\lambda_{\sf peak}$	typ.	472 nm
Dominant Wavelength <sup>3)</sup> I <sub>F</sub> = 350 mA	$\lambda_{dom}$	min. typ. max.	468 nm 475 nm 480 nm
Viewing angle at 50% I <sub>v</sub>	2φ	typ.	120 °
Forward Voltage <sup>4)</sup> I <sub>F</sub> = 350 mA	$V_{F}$	min. typ. max.	2.75 V 2.80 V 3.25 V
Reverse voltage (ESD device)	$V_{RESD}$	min.	5 V
Reverse voltage <sup>2)</sup> I <sub>R</sub> = 5 mA	$V_R$	max.	7 V
Real thermal resistance junction/solderpoint 5)	$R_{\text{thJS real}}$	typ. max.	9.6 K / W 10.8 K / W
Electrical thermal resistance junction/solderpoint $^{5)}$ with efficiency $\eta_e$ = 36 %	$R_{\text{thJS elec.}}$	typ. max.	6.1 K / W 6.9 K / W



# **Brightness Groups**

Group	Luminous Flux <sup>1)</sup> $I_F = 350 \text{ mA}$ min. $\Phi_V$	Luminous Flux <sup>1)</sup> $I_F = 350 \text{ mA}$ max. $\Phi_V$	Luminous Intensity $^{6)}$ $I_F = 350 \text{ mA}$ typ. $I_V$
HY	33 lm	39 lm	12 cd
HZ	39 lm	45 lm	14 cd
JX	45 lm	52 lm	16 cd
JY	52 lm	61 lm	19 cd
JZ	61 lm	71 lm	22 cd

# **Forward Voltage Groups**

Group Forward Voltage $^{4)}$ I <sub>F</sub> = 350 mA min. V <sub>F</sub>		Forward Voltage <sup>4)</sup> I <sub>F</sub> = 350 mA max. V <sub>F</sub>	
8E	2.75 V	3.00 V	
8F	3.00 V	3.25 V	

# **Wavelength Groups**

Group	Dominant Wavelength 3)	Dominant Wavelength 3)
	$I_{F} = 350 \text{ mA}$	$I_{F} = 350 \text{ mA}$
	min.	max.
	$\lambda_{dom}$	$\lambda_{\sf dom}$
4	468 nm	472 nm
5	472 nm	476 nm
6	476 nm	480 nm



# **Group Name on Label**

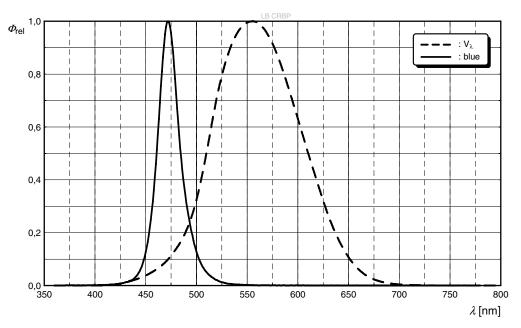
Example: HY-4-8E

Brightness	Wavelength	Forward Voltage
HY	4	8E



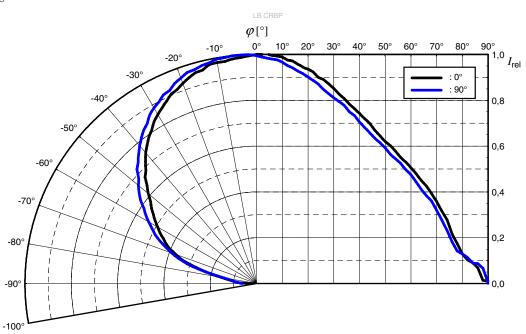
## Relative Spectral Emission 6)

$$\Phi_{rel}$$
 = f ( $\lambda$ ); I $_F$  = 350 mA; T $_S$  = 25 °C



### Radiation Characteristics 6)

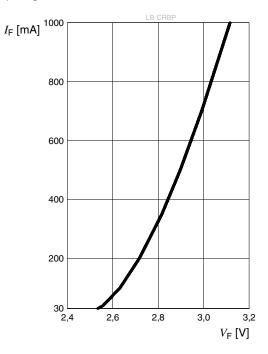
$$I_{rel} = f(\phi); T_S = 25 \, ^{\circ}C$$





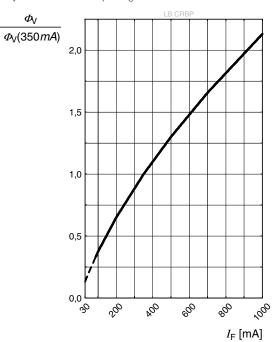
#### Forward current 6), 7)

$$I_F = f(V_F); T_S = 25 \, ^{\circ}C$$



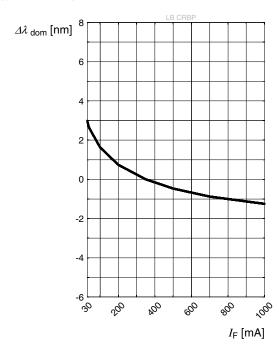
#### Relative Luminous Flux 6), 7)

$$\Phi_{V}/\Phi_{V}(350 \text{ mA}) = f(I_{F}); T_{S} = 25 \text{ °C}$$



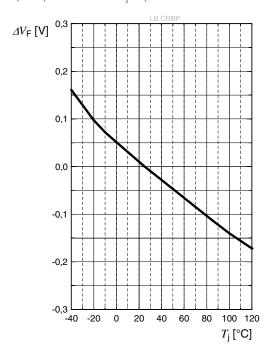
# Dominant Wavelength 6)

$$\Delta\lambda_{dom} = f(I_F); T_S = 25 \text{ }^{\circ}\text{C}$$



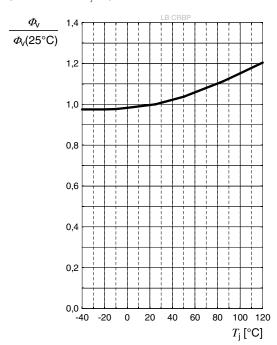
#### Forward Voltage 6)

$$\Delta V_{_F} = V_{_F} - V_{_F} (25 \ ^{\circ}\text{C}) = f(T_{_j}); \ I_{_F} = 350 \ \text{mA}$$



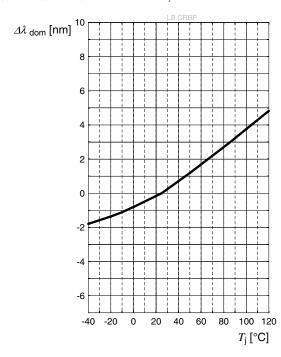
## Relative Luminous Flux 6)

$$\Phi_{v}/\Phi_{v}(25 \text{ °C}) = f(T_{i}); I_{F} = 350 \text{ mA}$$



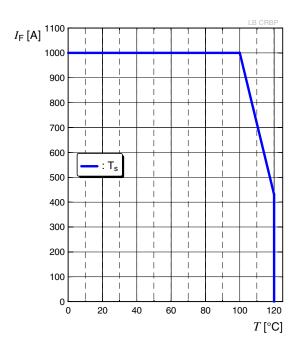
## **Dominant Wavelength** 6)

$$\Delta \lambda_{\text{dom}} = \lambda_{\text{dom}} - \lambda_{\text{dom}} (25 \ ^{\circ}\text{C}) = f(T_{j}); \ I_{\text{F}} = 350 \ \text{mA}$$



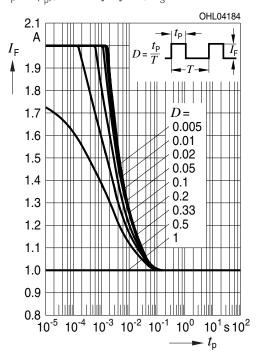
#### Max. Permissible Forward Current

 $I_F = f(T)$ 



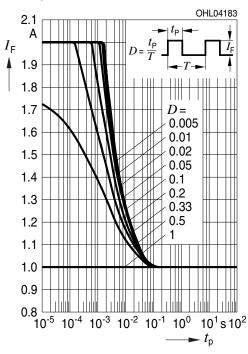
### Permissible Pulse Handling Capability

 $I_F = f(t_D)$ ; D: Duty cycle;  $T_S = 25 \, ^{\circ}\text{C}$ 

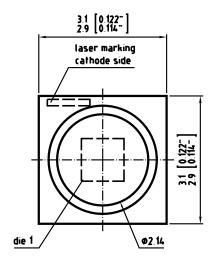


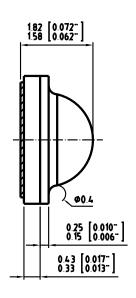
## **Permissible Pulse Handling Capability**

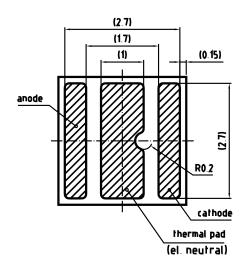
 $I_{_{\rm F}}$  = f(t $_{_{
m D}}$ ); D: Duty cycle;  $T_{_{
m S}}$  = 85 °C



## **Dimensional Drawing** 8)







C63062-A4226-A1..-01

#### **Further Information:**

**Approximate Weight:** 25.0 mg **Corrosion test:** Class: 3B

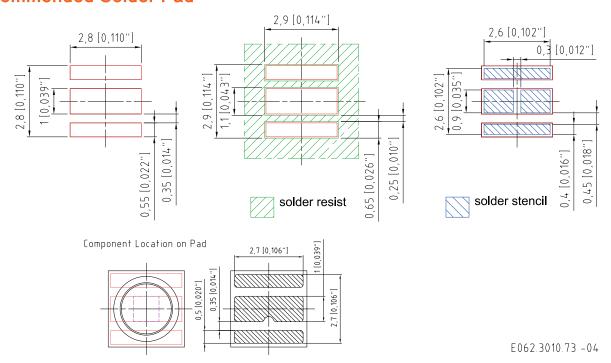
Test condition: 40°C / 90 % RH / 15 ppm H<sub>2</sub>S / 14 days (stricter than IEC

60068-2-43)

**ESD advice:** The device is protected by ESD device which is connected in parallel to the

Chip.

### Recommended Solder Pad 8)

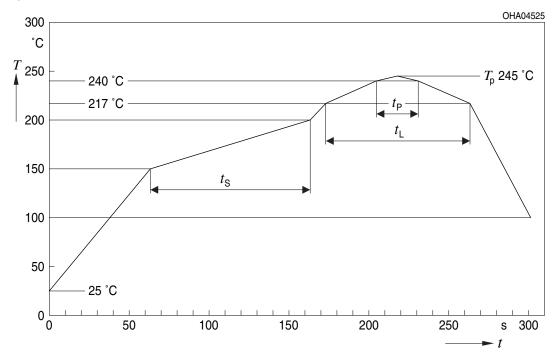


For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere. Package not suitable for ultra sonic cleaning.



### **Reflow Soldering Profile**

Product complies to MSL Level 2 acc. to JEDEC J-STD-020E



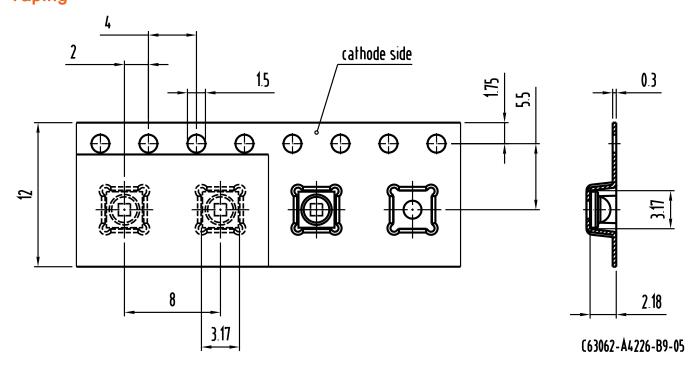
Profile Feature	Symbol	Pb-Free (SnAgCu) Assembly			Unit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat*)			2	3	K/s
25 °C to 150 °C					
Time t <sub>s</sub>	$t_s$	60	100	120	S
$T_{Smin}$ to $T_{Smax}$					
Ramp-up rate to peak*)			2	3	K/s
$T_{Smax}$ to $T_{P}$					
Liquidus temperature	$T_L$		217		°C
Time above liquidus temperature	$t_{\scriptscriptstyle \perp}$		80	100	S
Peak temperature	$T_{P}$		245	260	°C
Time within 5 °C of the specified peak	t <sub>P</sub>	10	20	30	S
temperature T <sub>P</sub> - 5 K					
Ramp-down rate*			3	6	K/s
T <sub>P</sub> to 100 °C					
Time				480	S
25 °C to T <sub>P</sub>					

All temperatures refer to the center of the package, measured on the top of the component



<sup>\*</sup> slope calculation DT/Dt: Dt max. 5 s; fulfillment for the whole T-range

# Taping 8)





## Tape and Reel 9)



#### **Reel Dimensions**

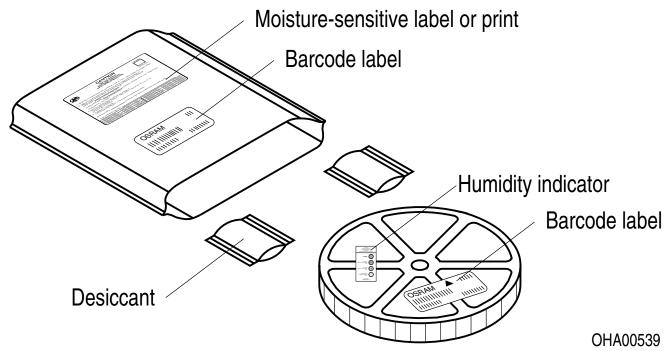
Α	W	$N_{\min}$	W <sub>1</sub>	$W_{2\text{max}}$	Pieces per PU
180 mm	12 + 0.3 / - 0.1 mm	60 mm	12.4 + 2 mm	18.4 mm	600



#### **Barcode-Product-Label (BPL)**



## Dry Packing Process and Materials 8)



Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.



# Type Designation System

Wavelength (λ <sub>dom</sub> typ.) B: 470 ni T: 528 ni Y: 587 ni J: 625 ni V: 505 ni	m blue m true m yello m red	green	CIE 193 CB: c CY: c	ordinates acc 1/Emission co color on dema color on dema ultra white	l <b>or:</b> nd blue	
L: Light emittir diode	ng			(cer	<b>Type</b> RAMOS, OSL ramic), OSLON npact	
L	В		С	L	7	Р
L: 0 2 R: 0 K: 0 Q: 0	ackage Prope OSLON Ceran D-Code Traffi OSLON Ceran Text gen(UX:3 OSLON Ceran ThinGan w/o 2 OSLON Ceran Chip up-date	nic Material A ic nic Material A V4, TiO2, HF nic Material A PD-Code Traff nic Material A	RI-layer IIN fic	lm w/o		
Enca 7: B:		/ Lens Proper glens (=80°) glens 120°; la				
	Chi <sub> </sub> P:	p <b>Technology</b> power pe	rformance			



#### **Notes**

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet falls into the class moderate risk (exposure time 0.25 s). Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related information please visit www.osram-os.com/appnotes



#### **Disclaimer**

#### Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on the OSRAM OS website.

#### **Packing**

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

#### Product and functional safety devices/applications or medical devices/applications

OSRAM OS components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

OSRAM OS products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using OSRAM OS components in product safety devices/applications or medical devices/applications, buyer and/or customer has to inform the local sales partner of OSRAM OS immediately and OSRAM OS and buyer and /or customer will analyze and coordinate the customer-specific request between OSRAM OS and buyer and/or customer.



#### Glossary

- Brightness: Brightness values are measured during a current pulse of typically 25 ms, with an internal reproducibility of  $\pm 8$  % and an expanded uncertainty of  $\pm 11$  % (acc. to GUM with a coverage factor of k = 3).
- Reverse Operation: Reverse Operation of 10 hours is permissible in total. Continuous reverse operation is not allowed.
- Wavelength: The wavelength is measured at a current pulse of typically 25 ms, with an internal reproducibility of ±0.5 nm and an expanded uncertainty of ±1 nm (acc. to GUM with a coverage factor of k = 3).
- Forward Voltage: The forward voltage is measured during a current pulse of typically 8 ms, with an internal reproducibility of  $\pm 0.05$  V and an expanded uncertainty of  $\pm 0.1$  V (acc. to GUM with a coverage factor of k = 3).
- Thermal Resistance: Rth max is based on statistic values  $(6\sigma)$ .
- Typical Values: Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- Characteristic curve: In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.
- Tolerance of Measure: Unless otherwise noted in drawing, tolerances are specified with ±0.1 and dimensions are specified in mm.
- <sup>9)</sup> **Tape and Reel:** All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.



Revision History				
Version	Date	Change		
1.10	2019-07-19	Features Further Information		
1.11	2020-03-23	Schematic Transportation Box Dimensions of Transportation Box		



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